

Global Flip-Chip Bumping Production, Demand and Key Producers, 2022-2028

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Abstracts

This report studies the global Flip-Chip Bumping production, demand, key manufacturers, and key regions.

This report is a detailed and comprehensive analysis of the world market for Flip-Chip Bumping, and provides market size (US\$ million) and Year-over-Year (YoY) Growth, considering 2021 as the base year. This report explores demand trends and competition, as well as details the characteristics of Flip-Chip Bumping that contribute to its increasing demand across many markets.

The global Flip-Chip Bumping market size is expected to reach \$ million by 2028, rising at a market growth of % CAGR during the forecast period (2022-2028).

Highlights and key features of the study

Global Flip-Chip Bumping total production and demand, 2017-2028, (Million Units)

Global Flip-Chip Bumping total production value, 2017-2028, (USD Million)

Global Flip-Chip Bumping production by region & country, production, value, CAGR, 2017-2028, (USD Million) & (Million Units)

Global Flip-Chip Bumping consumption by region & country, CAGR, 2017-2028 & (Million Units)

U.S. VS China: Flip-Chip Bumping domestic production, consumption, key domestic manufacturers and share

Global Flip-Chip Bumping production by manufacturer, production, price, value and market share 2017-2022, (USD Million) & (Million Units)

Global Flip-Chip Bumping production by Type, production, value, CAGR, 2017-2028, (USD Million) & (Million Units)

Global Flip-Chip Bumping production by Wafer Size production, value, CAGR, 2017-2028, (USD Million) & (Million Units)

This reports profiles key players in the global Flip-Chip Bumping market based on the following parameters – headquarters, production locations, products portfolio, Flip-Chip Bumping revenue, sales, average price and gross margin, recent developments.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals, COVID-19 and Russia-Ukraine War Influence.

Stakeholders would have ease in decision-making through various strategy matrices used in analyzing the World Flip-Chip Bumping market

Detailed Segmentation:

Each section contains quantitative market data including market by value (US\$ Millions), volume (production, consumption) & (Million Units) and average price (US\$/K Unit) by manufacturer, by Type, and by Wafer Size. Data is given for the years 2017-2028 by year with 2021 as the base year, 2022 as the estimate year, and 2028 as the forecast year.

Global Flip-Chip Bumping Market, By Region:

United States

China

Europe

Japan

South Korea

ASEAN

India

Global Flip-Chip Bumping Market, Segmentation by Type

Copper Pillar Bump (CPB)

CuNiAu Bumping

Sn Bumping

Gold Bump

Lead Free Bump

Others

Global Flip-Chip Bumping Market, Segmentation by Wafer Size

300mm Wafer

200mm Wafer

Companies Profiled:

Intel

Samsung

LB Semicon Inc

DuPont

FINECS

Amkor Technology

ASE

Raytek Semiconductor, Inc.

Winstek Semiconductor

Nepes

JiangYin ChangDian Advanced Packaging

sj company co., LTD.

SJ Semiconductor Co

Chipbond

Chip More

ChipMOS

Shenzhen Tongxingda Technology

MacDermid Alpha Electronics

Jiangsu CAS Microelectronics Integration

Tianshui Huatian Technology

JCET Group

Unisem Group

Powertech Technology Inc.

SFA Semicon

International Micro Industries

Jiangsu nepes Semiconductor

Jiangsu Yidu Technology

Key Questions Answered

1. How big is the global Flip-Chip Bumping market?
2. What is the demand of the global Flip-Chip Bumping market?
3. What is the year over year growth of the global Flip-Chip Bumping market?
4. What is the production and production value of the global Flip-Chip Bumping market?
5. Who are the key producers in the global Flip-Chip Bumping market?
6. What are the growth factors driving the market demand?

Contents

1 SUPPLY SUMMARY

- 1.1 Flip-Chip Bumping Introduction
- 1.2 World Flip-Chip Bumping Supply & Forecast
 - 1.2.1 World Flip-Chip Bumping Production Value (2017 & 2021 & 2028)
 - 1.2.2 World Flip-Chip Bumping Production (2017-2028)
 - 1.2.3 World Flip-Chip Bumping Pricing Trends (2017-2028)
- 1.3 World Flip-Chip Bumping Production by Region
 - 1.3.1 World Flip-Chip Bumping Production Value by Region (2017-2028)
 - 1.3.2 World Flip-Chip Bumping Production by Region (2017-2028)
 - 1.3.3 World Flip-Chip Bumping Average Price by Region (2017-2028)
 - 1.3.4 North America Flip-Chip Bumping Production (2017-2028)
 - 1.3.5 Europe Flip-Chip Bumping Production (2017-2028)
 - 1.3.6 China Flip-Chip Bumping Production (2017-2028)
 - 1.3.7 Japan Flip-Chip Bumping Production (2017-2028)
 - 1.3.8 China Taiwan Flip-Chip Bumping Production (2017-2028)
 - 1.3.9 South Korea Flip-Chip Bumping Production (2017-2028)
- 1.4 Market Drivers, Restraints and Trends
 - 1.4.1 Flip-Chip Bumping Market Drivers
 - 1.4.2 Factors Affecting Demand
 - 1.4.3 Flip-Chip Bumping Major Market Trends
- 1.5 Influence of COVID-19 and Russia-Ukraine War
 - 1.5.1 Influence of COVID-19
 - 1.5.2 Influence of Russia-Ukraine War

2 DEMAND SUMMARY

- 2.1 World Flip-Chip Bumping Demand (2017-2028)
- 2.2 World Flip-Chip Bumping Consumption by Region
 - 2.2.1 World Flip-Chip Bumping Consumption by Region (2017-2022)
 - 2.2.2 World Flip-Chip Bumping Consumption Forecast by Region (2023-2028)
- 2.3 United States Flip-Chip Bumping Consumption (2017-2028)
- 2.4 China Flip-Chip Bumping Consumption (2017-2028)
- 2.5 Europe Flip-Chip Bumping Consumption (2017-2028)
- 2.6 Japan Flip-Chip Bumping Consumption (2017-2028)
- 2.7 South Korea Flip-Chip Bumping Consumption (2017-2028)
- 2.8 ASEAN Flip-Chip Bumping Consumption (2017-2028)

2.9 India Flip-Chip Bumping Consumption (2017-2028)

3 WORLD FLIP-CHIP BUMPING MANUFACTURERS COMPETITIVE ANALYSIS

3.1 World Flip-Chip Bumping Production Value by Manufacturer (2017-2022)

3.2 World Flip-Chip Bumping Production by Manufacturer (2017-2022)

3.3 World Flip-Chip Bumping Average Price by Manufacturer (2017-2022)

3.4 Flip-Chip Bumping Company Evaluation Quadrant

3.5 Industry Rank and Concentration Rate (CR)

3.5.1 Global Flip-Chip Bumping Industry Rank of Major Manufacturers

3.5.2 Global Concentration Ratios (CR4) for Flip-Chip Bumping in 2021

3.5.3 Global Concentration Ratios (CR8) for Flip-Chip Bumping in 2021

3.6 Flip-Chip Bumping Market: Overall Company Footprint Analysis

3.6.1 Flip-Chip Bumping Market: Region Footprint

3.6.2 Flip-Chip Bumping Market: Company Product Type Footprint

3.6.3 Flip-Chip Bumping Market: Company Product Application Footprint

3.7 Competitive Environment

3.7.1 Historical Structure of the Industry

3.7.2 Barriers of Market Entry

3.7.3 Factors of Competition

3.8 New Entrant and Capacity Expansion Plans

3.9 Mergers, Acquisition, Agreements, and Collaborations

4 UNITED STATES VS CHINA VS REST OF THE WORLD

4.1 United States VS China: Flip-Chip Bumping Production Value Comparison

4.1.1 United States VS China: Flip-Chip Bumping Production Value Comparison (2017 & 2021 & 2028)

4.1.2 United States VS China: Flip-Chip Bumping Production Value Market Share Comparison (2017 & 2021 & 2028)

4.2 United States VS China: Flip-Chip Bumping Production Comparison

4.2.1 United States VS China: Flip-Chip Bumping Production Comparison (2017 & 2021 & 2028)

4.2.2 United States VS China: Flip-Chip Bumping Production Market Share Comparison (2017 & 2021 & 2028)

4.3 United States VS China: Flip-Chip Bumping Consumption Comparison

4.3.1 United States VS China: Flip-Chip Bumping Consumption Comparison (2017 & 2021 & 2028)

4.3.2 United States VS China: Flip-Chip Bumping Consumption Market Share

Comparison (2017 & 2021 & 2028)

4.4 United States Flip-Chip Bumping Key Producers and Market Share, 2017-2022

4.4.1 Major Manufacturer of Flip-Chip Bumping in United States, Company Headquarters and Production Place (States, Country)

4.4.2 United States Flip-Chip Bumping Production Value by Domestic Manufacturer, (2017-2022)

4.4.3 United States Flip-Chip Bumping Production by Domestic Manufacturer, (2017-2022)

4.5 China Flip-Chip Bumping Key Producers and Market Share, 2017-2022

4.5.1 Major Manufacturer of Flip-Chip Bumping in China, Company Headquarters and Production Place (Province, Country)

4.5.2 China Flip-Chip Bumping Production Value by Domestic Manufacturer, (2017-2022)

4.5.3 China Flip-Chip Bumping Production by Domestic Manufacturer, (2017-2022)

4.6 Rest of World Flip-Chip Bumping Key Producers and Market Share, 2017-2022

4.6.1 Major Manufacturer of Flip-Chip Bumping in Rest of World, Company Headquarters and Production Place (State, Country)

4.6.2 Rest of World Flip-Chip Bumping Production Value by Domestic Manufacturer, (2017-2022)

4.6.3 Rest of World Flip-Chip Bumping Production by Domestic Manufacturer, (2017-2022)

5 MARKET ANALYSIS BY TYPE

5.1 World Flip-Chip Bumping Market Size Overview by Type: 2017 VS 2021 VS 2028

5.2 Segment Introduction by Type

5.2.1 Copper Pillar Bump (CPB)

5.2.2 CuNiAu Bumping

5.2.3 Sn Bumping

5.2.4 Gold Bump

5.2.5 Lead Free Bump

5.2.6 Others

5.3 Market Segment by Type

5.3.1 World Flip-Chip Bumping Production by Type (2017-2028)

5.3.2 World Flip-Chip Bumping Production Value by Type (2017-2028)

5.3.3 World Flip-Chip Bumping Average Price by Type (2017-2028)

6 MARKET ANALYSIS BY WAFER SIZE

6.1 World Flip-Chip Bumping Market Size Overview by Wafer Size: 2017 VS 2021 VS 2028

6.2 Segment Introduction by Wafer Size

6.2.1 300mm Wafer

6.2.2 200mm Wafer

6.3 Market Segment by Wafer Size

6.3.1 World Flip-Chip Bumping Production by Wafer Size (2017-2028)

6.3.2 World Flip-Chip Bumping Production Value by Wafer Size (2017-2028)

6.3.3 World Flip-Chip Bumping Average Price by Wafer Size (2017-2028)

7 COMPANY PROFILES

7.1 Intel

7.1.1 Intel Details

7.1.2 Intel Major Business

7.1.3 Intel Flip-Chip Bumping Product and Services

7.1.4 Intel Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)

7.1.5 Intel Recent Developments/Updates

7.1.6 Intel Competitive Strengths & Weaknesses

7.2 Samsung

7.2.1 Samsung Details

7.2.2 Samsung Major Business

7.2.3 Samsung Flip-Chip Bumping Product and Services

7.2.4 Samsung Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)

7.2.5 Samsung Recent Developments/Updates

7.2.6 Samsung Competitive Strengths & Weaknesses

7.3 LB Semicon Inc

7.3.1 LB Semicon Inc Details

7.3.2 LB Semicon Inc Major Business

7.3.3 LB Semicon Inc Flip-Chip Bumping Product and Services

7.3.4 LB Semicon Inc Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)

7.3.5 LB Semicon Inc Recent Developments/Updates

7.3.6 LB Semicon Inc Competitive Strengths & Weaknesses

7.4 DuPont

7.4.1 DuPont Details

7.4.2 DuPont Major Business

- 7.4.3 DuPont Flip-Chip Bumping Product and Services
- 7.4.4 DuPont Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
- 7.4.5 DuPont Recent Developments/Updates
- 7.4.6 DuPont Competitive Strengths & Weaknesses
- 7.5 FINECS
 - 7.5.1 FINECS Details
 - 7.5.2 FINECS Major Business
 - 7.5.3 FINECS Flip-Chip Bumping Product and Services
 - 7.5.4 FINECS Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
 - 7.5.5 FINECS Recent Developments/Updates
 - 7.5.6 FINECS Competitive Strengths & Weaknesses
- 7.6 Amkor Technology
 - 7.6.1 Amkor Technology Details
 - 7.6.2 Amkor Technology Major Business
 - 7.6.3 Amkor Technology Flip-Chip Bumping Product and Services
 - 7.6.4 Amkor Technology Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
 - 7.6.5 Amkor Technology Recent Developments/Updates
 - 7.6.6 Amkor Technology Competitive Strengths & Weaknesses
- 7.7 ASE
 - 7.7.1 ASE Details
 - 7.7.2 ASE Major Business
 - 7.7.3 ASE Flip-Chip Bumping Product and Services
 - 7.7.4 ASE Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
 - 7.7.5 ASE Recent Developments/Updates
 - 7.7.6 ASE Competitive Strengths & Weaknesses
- 7.8 Raytek Semiconductor, Inc.
 - 7.8.1 Raytek Semiconductor, Inc. Details
 - 7.8.2 Raytek Semiconductor, Inc. Major Business
 - 7.8.3 Raytek Semiconductor, Inc. Flip-Chip Bumping Product and Services
 - 7.8.4 Raytek Semiconductor, Inc. Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
 - 7.8.5 Raytek Semiconductor, Inc. Recent Developments/Updates
 - 7.8.6 Raytek Semiconductor, Inc. Competitive Strengths & Weaknesses
- 7.9 Winstek Semiconductor
 - 7.9.1 Winstek Semiconductor Details

- 7.9.2 Winstek Semiconductor Major Business
- 7.9.3 Winstek Semiconductor Flip-Chip Bumping Product and Services
- 7.9.4 Winstek Semiconductor Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
- 7.9.5 Winstek Semiconductor Recent Developments/Updates
- 7.9.6 Winstek Semiconductor Competitive Strengths & Weaknesses
- 7.10 Nepes
 - 7.10.1 Nepes Details
 - 7.10.2 Nepes Major Business
 - 7.10.3 Nepes Flip-Chip Bumping Product and Services
 - 7.10.4 Nepes Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
 - 7.10.5 Nepes Recent Developments/Updates
 - 7.10.6 Nepes Competitive Strengths & Weaknesses
- 7.11 JiangYin ChangDian Advanced Packaging
 - 7.11.1 JiangYin ChangDian Advanced Packaging Details
 - 7.11.2 JiangYin ChangDian Advanced Packaging Major Business
 - 7.11.3 JiangYin ChangDian Advanced Packaging Flip-Chip Bumping Product and Services
 - 7.11.4 JiangYin ChangDian Advanced Packaging Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
 - 7.11.5 JiangYin ChangDian Advanced Packaging Recent Developments/Updates
 - 7.11.6 JiangYin ChangDian Advanced Packaging Competitive Strengths & Weaknesses
- 7.12 sj company co., LTD.
 - 7.12.1 sj company co., LTD. Details
 - 7.12.2 sj company co., LTD. Major Business
 - 7.12.3 sj company co., LTD. Flip-Chip Bumping Product and Services
 - 7.12.4 sj company co., LTD. Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
 - 7.12.5 sj company co., LTD. Recent Developments/Updates
 - 7.12.6 sj company co., LTD. Competitive Strengths & Weaknesses
- 7.13 SJ Semiconductor Co
 - 7.13.1 SJ Semiconductor Co Details
 - 7.13.2 SJ Semiconductor Co Major Business
 - 7.13.3 SJ Semiconductor Co Flip-Chip Bumping Product and Services
 - 7.13.4 SJ Semiconductor Co Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
 - 7.13.5 SJ Semiconductor Co Recent Developments/Updates

- 7.13.6 SJ Semiconductor Co Competitive Strengths & Weaknesses
- 7.14 Chipbond
 - 7.14.1 Chipbond Details
 - 7.14.2 Chipbond Major Business
 - 7.14.3 Chipbond Flip-Chip Bumping Product and Services
 - 7.14.4 Chipbond Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
 - 7.14.5 Chipbond Recent Developments/Updates
 - 7.14.6 Chipbond Competitive Strengths & Weaknesses
- 7.15 Chip More
 - 7.15.1 Chip More Details
 - 7.15.2 Chip More Major Business
 - 7.15.3 Chip More Flip-Chip Bumping Product and Services
 - 7.15.4 Chip More Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
 - 7.15.5 Chip More Recent Developments/Updates
 - 7.15.6 Chip More Competitive Strengths & Weaknesses
- 7.16 ChipMOS
 - 7.16.1 ChipMOS Details
 - 7.16.2 ChipMOS Major Business
 - 7.16.3 ChipMOS Flip-Chip Bumping Product and Services
 - 7.16.4 ChipMOS Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
 - 7.16.5 ChipMOS Recent Developments/Updates
 - 7.16.6 ChipMOS Competitive Strengths & Weaknesses
- 7.17 Shenzhen Tongxingda Technology
 - 7.17.1 Shenzhen Tongxingda Technology Details
 - 7.17.2 Shenzhen Tongxingda Technology Major Business
 - 7.17.3 Shenzhen Tongxingda Technology Flip-Chip Bumping Product and Services
 - 7.17.4 Shenzhen Tongxingda Technology Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
 - 7.17.5 Shenzhen Tongxingda Technology Recent Developments/Updates
 - 7.17.6 Shenzhen Tongxingda Technology Competitive Strengths & Weaknesses
- 7.18 MacDermid Alpha Electronics
 - 7.18.1 MacDermid Alpha Electronics Details
 - 7.18.2 MacDermid Alpha Electronics Major Business
 - 7.18.3 MacDermid Alpha Electronics Flip-Chip Bumping Product and Services
 - 7.18.4 MacDermid Alpha Electronics Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)

- 7.18.5 MacDermid Alpha Electronics Recent Developments/Updates
- 7.18.6 MacDermid Alpha Electronics Competitive Strengths & Weaknesses
- 7.19 Jiangsu CAS Microelectronics Integration
 - 7.19.1 Jiangsu CAS Microelectronics Integration Details
 - 7.19.2 Jiangsu CAS Microelectronics Integration Major Business
 - 7.19.3 Jiangsu CAS Microelectronics Integration Flip-Chip Bumping Product and Services
 - 7.19.4 Jiangsu CAS Microelectronics Integration Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
 - 7.19.5 Jiangsu CAS Microelectronics Integration Recent Developments/Updates
 - 7.19.6 Jiangsu CAS Microelectronics Integration Competitive Strengths & Weaknesses
- 7.20 Tianshui Huatian Technology
 - 7.20.1 Tianshui Huatian Technology Details
 - 7.20.2 Tianshui Huatian Technology Major Business
 - 7.20.3 Tianshui Huatian Technology Flip-Chip Bumping Product and Services
 - 7.20.4 Tianshui Huatian Technology Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
 - 7.20.5 Tianshui Huatian Technology Recent Developments/Updates
 - 7.20.6 Tianshui Huatian Technology Competitive Strengths & Weaknesses
- 7.21 JCET Group
 - 7.21.1 JCET Group Details
 - 7.21.2 JCET Group Major Business
 - 7.21.3 JCET Group Flip-Chip Bumping Product and Services
 - 7.21.4 JCET Group Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
 - 7.21.5 JCET Group Recent Developments/Updates
 - 7.21.6 JCET Group Competitive Strengths & Weaknesses
- 7.22 Unisem Group
 - 7.22.1 Unisem Group Details
 - 7.22.2 Unisem Group Major Business
 - 7.22.3 Unisem Group Flip-Chip Bumping Product and Services
 - 7.22.4 Unisem Group Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)
 - 7.22.5 Unisem Group Recent Developments/Updates
 - 7.22.6 Unisem Group Competitive Strengths & Weaknesses
- 7.23 Powertech Technology Inc.
 - 7.23.1 Powertech Technology Inc. Details
 - 7.23.2 Powertech Technology Inc. Major Business
 - 7.23.3 Powertech Technology Inc. Flip-Chip Bumping Product and Services

7.23.4 Powertech Technology Inc. Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)

7.23.5 Powertech Technology Inc. Recent Developments/Updates

7.23.6 Powertech Technology Inc. Competitive Strengths & Weaknesses

7.24 SFA Semicon

7.24.1 SFA Semicon Details

7.24.2 SFA Semicon Major Business

7.24.3 SFA Semicon Flip-Chip Bumping Product and Services

7.24.4 SFA Semicon Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)

7.24.5 SFA Semicon Recent Developments/Updates

7.24.6 SFA Semicon Competitive Strengths & Weaknesses

7.25 International Micro Industries

7.25.1 International Micro Industries Details

7.25.2 International Micro Industries Major Business

7.25.3 International Micro Industries Flip-Chip Bumping Product and Services

7.25.4 International Micro Industries Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)

7.25.5 International Micro Industries Recent Developments/Updates

7.25.6 International Micro Industries Competitive Strengths & Weaknesses

7.26 Jiangsu nepes Semiconductor

7.26.1 Jiangsu nepes Semiconductor Details

7.26.2 Jiangsu nepes Semiconductor Major Business

7.26.3 Jiangsu nepes Semiconductor Flip-Chip Bumping Product and Services

7.26.4 Jiangsu nepes Semiconductor Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)

7.26.5 Jiangsu nepes Semiconductor Recent Developments/Updates

7.26.6 Jiangsu nepes Semiconductor Competitive Strengths & Weaknesses

7.27 Jiangsu Yidu Technology

7.27.1 Jiangsu Yidu Technology Details

7.27.2 Jiangsu Yidu Technology Major Business

7.27.3 Jiangsu Yidu Technology Flip-Chip Bumping Product and Services

7.27.4 Jiangsu Yidu Technology Flip-Chip Bumping Production, Price, Value, Gross Margin and Market Share (2017-2022)

7.27.5 Jiangsu Yidu Technology Recent Developments/Updates

7.27.6 Jiangsu Yidu Technology Competitive Strengths & Weaknesses

8 RAW MATERIAL AND INDUSTRY CHAIN

- 8.1 Raw Material of Flip-Chip Bumping and Key Manufacturers
- 8.2 Flip-Chip Bumping Manufacturing Costs
- 8.3 Flip-Chip Bumping Production Process
- 8.4 Flip-Chip Bumping Industrial Chain

9 DISTRIBUTION CHANNEL ANALYSIS

- 9.1 Distribution Channel Breakdown for Flip-Chip Bumping Shipments (%): 2017-2028
 - 9.1.1 Direct Channel
 - 9.1.2 Indirect Channel
- 9.2 Flip-Chip Bumping Typical Distributors
- 9.3 Flip-Chip Bumping Typical Customers

10 RESEARCH FINDINGS AND CONCLUSION

11 APPENDIX

- 11.1 Methodology
- 11.2 Research Process and Data Source
- 11.3 Disclaimer

List Of Tables

LIST OF TABLES

Table 1. World Flip-Chip Bumping Production Value by Region (2017, 2022 and 2028) & (USD Million)

Table 2. World Flip-Chip Bumping Production Value by Region (2017-2022) & (USD Million)

Table 3. World Flip-Chip Bumping Production Value by Region (2023-2028) & (USD Million)

Table 4. World Flip-Chip Bumping Production Value Market Share by Region (2017-2022)

Table 5. World Flip-Chip Bumping Production Value Market Share by Region (2023-2028)

Table 6. World Flip-Chip Bumping Production by Region (2017-2022) & (Million Units)

Table 7. World Flip-Chip Bumping Production by Region (2023-2028) & (Million Units)

Table 8. World Flip-Chip Bumping Production Market Share by Region (2017-2022)

Table 9. World Flip-Chip Bumping Production Market Share by Region (2023-2028)

Table 10. World Flip-Chip Bumping Average Price by Region (2017-2022) & (US\$/K Unit)

Table 11. World Flip-Chip Bumping Average Price by Region (2023-2028) & (US\$/K Unit)

Table 12. Flip-Chip Bumping Major Market Trends

Table 13. World Flip-Chip Bumping Consumption Growth Rate Forecast by Region (2017 & 2021 & 2028) & (Million Units)

Table 14. World Flip-Chip Bumping Consumption by Region (2017-2022) & (Million Units)

Table 15. World Flip-Chip Bumping Consumption Forecast by Region (2023-2028) & (Million Units)

Table 16. World Flip-Chip Bumping Production Value by Manufacturer (2017-2022) & (USD Million)

Table 17. Production Value Market Share of Key Flip-Chip Bumping Producers in 2021

Table 18. World Flip-Chip Bumping Production by Manufacturer (2017-2022) & (Million Units)

Table 19. Production Market Share of Key Flip-Chip Bumping Producers in 2021

Table 20. World Flip-Chip Bumping Average Price by Manufacturer (2017-2022) & (US\$/K Unit)

Table 21. Global Flip-Chip Bumping Company Evaluation Quadrant

Table 22. World Flip-Chip Bumping Industry Rank of Major Manufacturers, Based on

Production Value in 2021

Table 23. Head Office and Flip-Chip Bumping Production Site of Key Manufacturer

Table 24. Flip-Chip Bumping Market: Company Product Type Footprint

Table 25. Flip-Chip Bumping Market: Company Product Application Footprint

Table 26. Flip-Chip Bumping Competitive Factors

Table 27. Flip-Chip Bumping New Entrant and Capacity Expansion Plans

Table 28. Flip-Chip Bumping Mergers & Acquisitions Activity

Table 29. United States VS China Flip-Chip Bumping Production Value Comparison, (2017 & 2021 & 2028) & (USD Million)

Table 30. United States VS China Flip-Chip Bumping Production Comparison, (2017 & 2021 & 2028) & (Million Units)

Table 31. United States VS China Flip-Chip Bumping Consumption Comparison, (2017 & 2021 & 2028) & (Million Units)

Table 32. Major Manufacturer of Flip-Chip Bumping in United States, Company Headquarters and Production Place (States, Country)

Table 33. United States Flip-Chip Bumping Production Value by Domestic Manufacturer, (2017-2022) & (USD Million)

Table 34. United States Flip-Chip Bumping Production Value Market Share by Domestic Manufacturer, (2017-2022)

Table 35. United States Flip-Chip Bumping Production by Domestic Manufacturer, (2017-2022) & (Million Units)

Table 36. United States Flip-Chip Bumping Production Market Share by Domestic Manufacturer, (2017-2022)

Table 37. Major Manufacturer of Flip-Chip Bumping in China, Company Headquarters and Production Place (Province, Country)

Table 38. China Flip-Chip Bumping Production Value by Domestic Manufacturer, (2017-2022) & (USD Million)

Table 39. China Flip-Chip Bumping Production Value Market Share by Domestic Manufacturer, (2017-2022)

Table 40. China Flip-Chip Bumping Production by Domestic Manufacturer, (2017-2022) & (Million Units)

Table 41. China Flip-Chip Bumping Production Market Share by Domestic Manufacturer, (2017-2022)

Table 42. Major Manufacturer of Flip-Chip Bumping in Rest of World, Company Headquarters and Production Place (State, Country)

Table 43. Rest of World Flip-Chip Bumping Production Value by Domestic Manufacturer, (2017-2022) & (USD Million)

Table 44. Rest of World Flip-Chip Bumping Production Value Market Share by Domestic Manufacturer, (2017-2022)

Table 45. Rest of World Flip-Chip Bumping Production by Domestic Manufacturer, (2017-2022) & (Million Units)

Table 46. Rest of World Flip-Chip Bumping Production Market Share by Domestic Manufacturer, (2017-2022)

Table 47. World Flip-Chip Bumping Production Value by Type, (USD Million), 2017 & 2021 & 2028

Table 48. World Flip-Chip Bumping Production by Type (2017-2022) & (Million Units)

Table 49. World Flip-Chip Bumping Production by Type (2023-2028) & (Million Units)

Table 50. World Flip-Chip Bumping Production Value by Type (2017-2022) & (USD Million)

Table 51. World Flip-Chip Bumping Production Value by Type (2023-2028) & (USD Million)

Table 52. World Flip-Chip Bumping Average Price by Type (2017-2022) & (US\$/K Unit)

Table 53. World Flip-Chip Bumping Average Price by Type (2023-2028) & (US\$/K Unit)

Table 54. World Flip-Chip Bumping Production Value by Wafer Size, (USD Million), 2017 & 2021 & 2028

Table 55. World Flip-Chip Bumping Production by Wafer Size (2017-2022) & (Million Units)

Table 56. World Flip-Chip Bumping Production by Wafer Size (2023-2028) & (Million Units)

Table 57. World Flip-Chip Bumping Production Value by Wafer Size (2017-2022) & (USD Million)

Table 58. World Flip-Chip Bumping Production Value by Wafer Size (2023-2028) & (USD Million)

Table 59. World Flip-Chip Bumping Average Price by Wafer Size (2017-2022) & (US\$/K Unit)

Table 60. World Flip-Chip Bumping Average Price by Wafer Size (2023-2028) & (US\$/K Unit)

Table 61. Intel Basic Information, Manufacturing Base and Competitors

Table 62. Intel Major Business

Table 63. Intel Flip-Chip Bumping Product and Services

Table 64. Intel Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 65. Intel Recent Developments/Updates

Table 66. Intel Competitive Strengths & Weaknesses

Table 67. Samsung Basic Information, Manufacturing Base and Competitors

Table 68. Samsung Major Business

Table 69. Samsung Flip-Chip Bumping Product and Services

Table 70. Samsung Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit),

Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 71. Samsung Recent Developments/Updates

Table 72. Samsung Competitive Strengths & Weaknesses

Table 73. LB Semicon Inc Basic Information, Manufacturing Base and Competitors

Table 74. LB Semicon Inc Major Business

Table 75. LB Semicon Inc Flip-Chip Bumping Product and Services

Table 76. LB Semicon Inc Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 77. LB Semicon Inc Recent Developments/Updates

Table 78. LB Semicon Inc Competitive Strengths & Weaknesses

Table 79. DuPont Basic Information, Manufacturing Base and Competitors

Table 80. DuPont Major Business

Table 81. DuPont Flip-Chip Bumping Product and Services

Table 82. DuPont Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 83. DuPont Recent Developments/Updates

Table 84. DuPont Competitive Strengths & Weaknesses

Table 85. FINECS Basic Information, Manufacturing Base and Competitors

Table 86. FINECS Major Business

Table 87. FINECS Flip-Chip Bumping Product and Services

Table 88. FINECS Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 89. FINECS Recent Developments/Updates

Table 90. FINECS Competitive Strengths & Weaknesses

Table 91. Amkor Technology Basic Information, Manufacturing Base and Competitors

Table 92. Amkor Technology Major Business

Table 93. Amkor Technology Flip-Chip Bumping Product and Services

Table 94. Amkor Technology Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 95. Amkor Technology Recent Developments/Updates

Table 96. Amkor Technology Competitive Strengths & Weaknesses

Table 97. ASE Basic Information, Manufacturing Base and Competitors

Table 98. ASE Major Business

Table 99. ASE Flip-Chip Bumping Product and Services

Table 100. ASE Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 101. ASE Recent Developments/Updates

Table 102. ASE Competitive Strengths & Weaknesses

Table 103. Raytek Semiconductor, Inc. Basic Information, Manufacturing Base and Competitors

Table 104. Raytek Semiconductor, Inc. Major Business

Table 105. Raytek Semiconductor, Inc. Flip-Chip Bumping Product and Services

Table 106. Raytek Semiconductor, Inc. Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 107. Raytek Semiconductor, Inc. Recent Developments/Updates

Table 108. Raytek Semiconductor, Inc. Competitive Strengths & Weaknesses

Table 109. Winstek Semiconductor Basic Information, Manufacturing Base and Competitors

Table 110. Winstek Semiconductor Major Business

Table 111. Winstek Semiconductor Flip-Chip Bumping Product and Services

Table 112. Winstek Semiconductor Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 113. Winstek Semiconductor Recent Developments/Updates

Table 114. Winstek Semiconductor Competitive Strengths & Weaknesses

Table 115. Nepes Basic Information, Manufacturing Base and Competitors

Table 116. Nepes Major Business

Table 117. Nepes Flip-Chip Bumping Product and Services

Table 118. Nepes Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 119. Nepes Recent Developments/Updates

Table 120. Nepes Competitive Strengths & Weaknesses

Table 121. JiangYin ChangDian Advanced Packaging Basic Information, Manufacturing Base and Competitors

Table 122. JiangYin ChangDian Advanced Packaging Major Business

Table 123. JiangYin ChangDian Advanced Packaging Flip-Chip Bumping Product and Services

Table 124. JiangYin ChangDian Advanced Packaging Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 125. JiangYin ChangDian Advanced Packaging Recent Developments/Updates

Table 126. JiangYin ChangDian Advanced Packaging Competitive Strengths & Weaknesses

Table 127. sj company co., LTD. Basic Information, Manufacturing Base and Competitors

Table 128. sj company co., LTD. Major Business

Table 129. sj company co., LTD. Flip-Chip Bumping Product and Services

Table 130. sj company co., LTD. Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 131. sj company co., LTD. Recent Developments/Updates

Table 132. sj company co., LTD. Competitive Strengths & Weaknesses

Table 133. SJ Semiconductor Co Basic Information, Manufacturing Base and Competitors

Table 134. SJ Semiconductor Co Major Business

Table 135. SJ Semiconductor Co Flip-Chip Bumping Product and Services

Table 136. SJ Semiconductor Co Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 137. SJ Semiconductor Co Recent Developments/Updates

Table 138. SJ Semiconductor Co Competitive Strengths & Weaknesses

Table 139. Chipbond Basic Information, Manufacturing Base and Competitors

Table 140. Chipbond Major Business

Table 141. Chipbond Flip-Chip Bumping Product and Services

Table 142. Chipbond Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 143. Chipbond Recent Developments/Updates

Table 144. Chipbond Competitive Strengths & Weaknesses

Table 145. Chip More Basic Information, Manufacturing Base and Competitors

Table 146. Chip More Major Business

Table 147. Chip More Flip-Chip Bumping Product and Services

Table 148. Chip More Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 149. Chip More Recent Developments/Updates

Table 150. Chip More Competitive Strengths & Weaknesses

Table 151. ChipMOS Basic Information, Manufacturing Base and Competitors

Table 152. ChipMOS Major Business

Table 153. ChipMOS Flip-Chip Bumping Product and Services

Table 154. ChipMOS Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 155. ChipMOS Recent Developments/Updates

Table 156. ChipMOS Competitive Strengths & Weaknesses

Table 157. Shenzhen Tongxingda Technology Basic Information, Manufacturing Base and Competitors

Table 158. Shenzhen Tongxingda Technology Major Business

Table 159. Shenzhen Tongxingda Technology Flip-Chip Bumping Product and Services

Table 160. Shenzhen Tongxingda Technology Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 161. Shenzhen Tongxingda Technology Recent Developments/Updates

Table 162. Shenzhen Tongxingda Technology Competitive Strengths & Weaknesses

Table 163. MacDermid Alpha Electronics Basic Information, Manufacturing Base and Competitors

Table 164. MacDermid Alpha Electronics Major Business

Table 165. MacDermid Alpha Electronics Flip-Chip Bumping Product and Services

Table 166. MacDermid Alpha Electronics Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 167. MacDermid Alpha Electronics Recent Developments/Updates

Table 168. MacDermid Alpha Electronics Competitive Strengths & Weaknesses

Table 169. Jiangsu CAS Microelectronics Integration Basic Information, Manufacturing Base and Competitors

Table 170. Jiangsu CAS Microelectronics Integration Major Business

Table 171. Jiangsu CAS Microelectronics Integration Flip-Chip Bumping Product and Services

Table 172. Jiangsu CAS Microelectronics Integration Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 173. Jiangsu CAS Microelectronics Integration Recent Developments/Updates

Table 174. Jiangsu CAS Microelectronics Integration Competitive Strengths & Weaknesses

Table 175. Tianshui Huatian Technology Basic Information, Manufacturing Base and Competitors

Table 176. Tianshui Huatian Technology Major Business

Table 177. Tianshui Huatian Technology Flip-Chip Bumping Product and Services

Table 178. Tianshui Huatian Technology Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 179. Tianshui Huatian Technology Recent Developments/Updates

Table 180. Tianshui Huatian Technology Competitive Strengths & Weaknesses

Table 181. JCET Group Basic Information, Manufacturing Base and Competitors

Table 182. JCET Group Major Business

Table 183. JCET Group Flip-Chip Bumping Product and Services

Table 184. JCET Group Flip-Chip Bumping Production (Million Units), Price (US\$/K

Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 185. JCET Group Recent Developments/Updates

Table 186. JCET Group Competitive Strengths & Weaknesses

Table 187. Unisem Group Basic Information, Manufacturing Base and Competitors

Table 188. Unisem Group Major Business

Table 189. Unisem Group Flip-Chip Bumping Product and Services

Table 190. Unisem Group Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 191. Unisem Group Recent Developments/Updates

Table 192. Unisem Group Competitive Strengths & Weaknesses

Table 193. Powertech Technology Inc. Basic Information, Manufacturing Base and Competitors

Table 194. Powertech Technology Inc. Major Business

Table 195. Powertech Technology Inc. Flip-Chip Bumping Product and Services

Table 196. Powertech Technology Inc. Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 197. Powertech Technology Inc. Recent Developments/Updates

Table 198. Powertech Technology Inc. Competitive Strengths & Weaknesses

Table 199. SFA Semicon Basic Information, Manufacturing Base and Competitors

Table 200. SFA Semicon Major Business

Table 201. SFA Semicon Flip-Chip Bumping Product and Services

Table 202. SFA Semicon Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 203. SFA Semicon Recent Developments/Updates

Table 204. SFA Semicon Competitive Strengths & Weaknesses

Table 205. International Micro Industries Basic Information, Manufacturing Base and Competitors

Table 206. International Micro Industries Major Business

Table 207. International Micro Industries Flip-Chip Bumping Product and Services

Table 208. International Micro Industries Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 209. International Micro Industries Recent Developments/Updates

Table 210. International Micro Industries Competitive Strengths & Weaknesses

Table 211. Jiangsu nepes Semiconductor Basic Information, Manufacturing Base and Competitors

Table 212. Jiangsu nepes Semiconductor Major Business

Table 213. Jiangsu nepes Semiconductor Flip-Chip Bumping Product and Services

Table 214. Jiangsu nepes Semiconductor Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 215. Jiangsu nepes Semiconductor Recent Developments/Updates

Table 216. Jiangsu Yidu Technology Basic Information, Manufacturing Base and Competitors

Table 217. Jiangsu Yidu Technology Major Business

Table 218. Jiangsu Yidu Technology Flip-Chip Bumping Product and Services

Table 219. Jiangsu Yidu Technology Flip-Chip Bumping Production (Million Units), Price (US\$/K Unit), Production Value (USD Million), Gross Margin and Market Share (2017-2022)

Table 220. Flip-Chip Bumping Raw Material

Table 221. Key Manufacturers of Flip-Chip Bumping Raw Materials

Table 222. Flip-Chip Bumping Typical Distributors

Table 223. Flip-Chip Bumping Typical Customers

List Of Figures

LIST OF FIGURES

Figure 1. Flip-Chip Bumping Picture

Figure 2. World Flip-Chip Bumping Production Value: 2017 & 2021 & 2028, (USD Million)

Figure 3. World Flip-Chip Bumping Production Value and Forecast (2017-2028) & (USD Million)

Figure 4. World Flip-Chip Bumping Production (2017-2028) & (Million Units)

Figure 5. World Flip-Chip Bumping Average Price (2017-2028) & (US\$/K Unit)

Figure 6. World Flip-Chip Bumping Production Value Market Share by Region (2017-2028)

Figure 7. World Flip-Chip Bumping Production Market Share by Region (2017-2028)

Figure 8. North America Flip-Chip Bumping Production (2017-2028) & (Million Units)

Figure 9. Europe Flip-Chip Bumping Production (2017-2028) & (Million Units)

Figure 10. China Flip-Chip Bumping Production (2017-2028) & (Million Units)

Figure 11. Japan Flip-Chip Bumping Production (2017-2028) & (Million Units)

Figure 12. China Taiwan Flip-Chip Bumping Production (2017-2028) & (Million Units)

Figure 13. South Korea Flip-Chip Bumping Production (2017-2028) & (Million Units)

Figure 14. Flip-Chip Bumping Market Drivers

Figure 15. Factors Affecting Demand

Figure 16. World Flip-Chip Bumping Demand (2017-2028) & (Million Units)

Figure 17. World Flip-Chip Bumping Consumption Market Share by Region (2017-2028)

Figure 18. United States Flip-Chip Bumping Consumption (2017-2028) & (Million Units)

Figure 19. China Flip-Chip Bumping Consumption (2017-2028) & (Million Units)

Figure 20. Europe Flip-Chip Bumping Consumption (2017-2028) & (Million Units)

Figure 21. Japan Flip-Chip Bumping Consumption (2017-2028) & (Million Units)

Figure 22. South Korea Flip-Chip Bumping Consumption (2017-2028) & (Million Units)

Figure 23. ASEAN Flip-Chip Bumping Consumption (2017-2028) & (Million Units)

Figure 24. India Flip-Chip Bumping Consumption (2017-2028) & (Million Units)

Figure 25. Producer Shipments of Flip-Chip Bumping by Manufacturer Revenue (\$MM) and Market Share (%): 2021

Figure 26. Global Four-firm Concentration Ratios (CR4) for Flip-Chip Bumping Markets in 2021

Figure 27. Global Four-firm Concentration Ratios (CR8) for Flip-Chip Bumping Markets in 2021

Figure 28. United States VS China: Flip-Chip Bumping Production Value Market Share Comparison (2017 & 2021 & 2028)

Figure 29. United States VS China: Flip-Chip Bumping Production Market Share Comparison (2017 & 2021 & 2028)

Figure 30. United States VS China: Flip-Chip Bumping Consumption Market Share Comparison (2017 & 2021 & 2028)

Figure 31. Key Producers and Market Share of Flip-Chip Bumping in United States

Figure 32. Key Producers and Market Share of Flip-Chip Bumping in China

Figure 33. Key Producers and Market Share of Flip-Chip Bumping in Rest of World

Figure 34. World Flip-Chip Bumping Production Value by Type, (USD Million), 2017 & 2021 & 2028

Figure 35. World Flip-Chip Bumping Production Value Market Share by Type in 2021

Figure 36. Copper Pillar Bump (CPB)

Figure 37. CuNiAu Bumping

Figure 38. Sn Bumping

Figure 39. Gold Bump

Figure 40. Lead Free Bump

Figure 41. Others

Figure 42. World Flip-Chip Bumping Production Market Share by Type (2017-2028)

Figure 43. World Flip-Chip Bumping Production Value Market Share by Type (2017-2028)

Figure 44. World Flip-Chip Bumping Average Price by Type (2017-2028) & (US\$/K Unit)

Figure 45. World Flip-Chip Bumping Production Value by Wafer Size, (USD Million), 2017 & 2021 & 2028

Figure 46. World Flip-Chip Bumping Production Value Market Share by Wafer Size in 2021

Figure 47. 300mm Wafer

Figure 48. 200mm Wafer

Figure 49. World Flip-Chip Bumping Production Market Share by Wafer Size (2017-2028)

Figure 50. World Flip-Chip Bumping Production Value Market Share by Wafer Size (2017-2028)

Figure 51. World Flip-Chip Bumping Average Price by Wafer Size (2017-2028) & (US\$/K Unit)

Figure 52. Manufacturing Cost Structure Analysis of Flip-Chip Bumping in 2021

Figure 53. Manufacturing Process Analysis of Flip-Chip Bumping

Figure 54. Flip-Chip Bumping Industrial Chain

Figure 55. Distribution Channel Breakdown for Flip-Chip Bumping Shipments (%): 2017-2028

Figure 56. Direct Channel Pros & Cons

Figure 57. Indirect Channel Pros & Cons

Figure 58. Methodology

Figure 59. Research Process and Data Source

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